



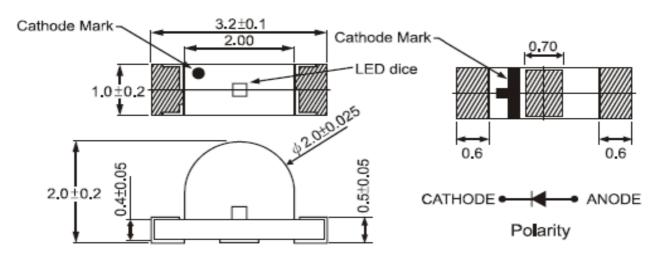




### **Applications**

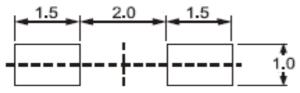
- Interior automotive lightingOptical indicatorsCommunication Products
- Communication Products
  Backlighting
  - Toys

### **Technical Drawing**

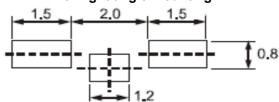


### **Recommended Soldering Pattern**

# For upright mounting



## For right angle mounting



#### Notes:

All dimensions in mm tolerance is  $\pm 0.1$ mm unless otherwise noted.

## SMT Chip LED Green

Part No.: **M11K4006** 

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## **Absolute Maximum Ratings**

Ta=25°C

Item	Symbol	GaP	Unit
Power Dissipation	$P_{D}$		mW
DC Forward Current	I <sub>F</sub>	30	mA
Plused Forward Current	I <sub>FP</sub> *	100	mA
Reverse Voltage	$V_R$	5	V
Operating Temperature	T <sub>OP</sub>	-25 to 80	°C
Storage Temperature	T <sub>ST</sub>	-30 to 85	°C

<sup>\* 0.1</sup> msec pulse, 10% duty cycle

## Electrcal / Optical Characteristics

I<sub>F</sub>=20mA Ta=25°C

Ermitting Color		Green	
Material		GaP	
Forward Voltage	typ.	2.2	$V_{F}$
Torward voitage	max.	2.6	$V_{F}$
Wavelength	λD	570	nm
	λP	568	nm
typ.	Δλ		nm
Color Temperature	min.		K
Color remperature	max.		K
Luminous Intensity *	min.	8.2	mcd
Luminous intensity	typ.	20	mcd
Reverse Current	max.		μA
Viewing Angle	201/2	100	

<sup>\*</sup> Per NIST standards

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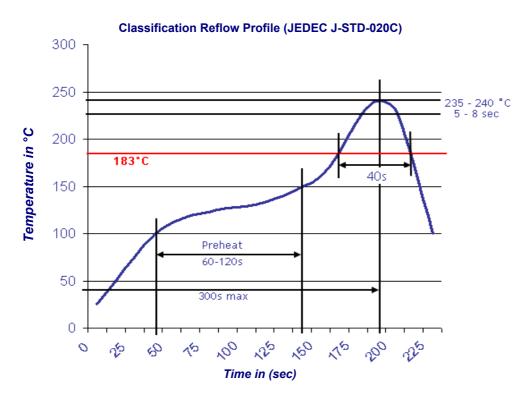






### **Solder Condition**

### Lead Free Solder



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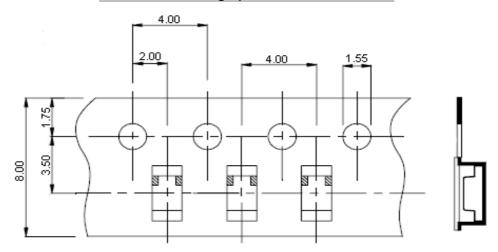




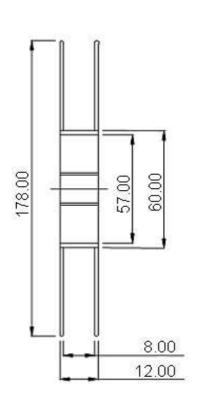


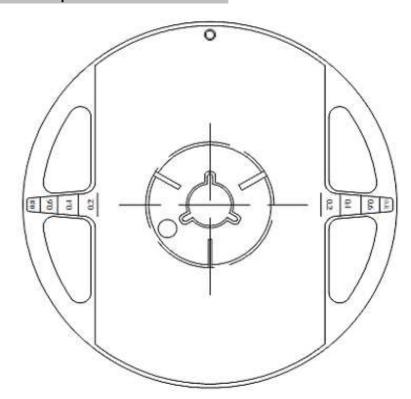


## **Packing Specifications**



### **Reel Specifications**





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### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.





3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



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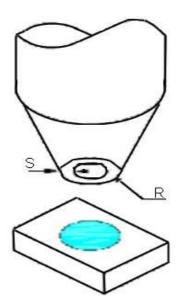








- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



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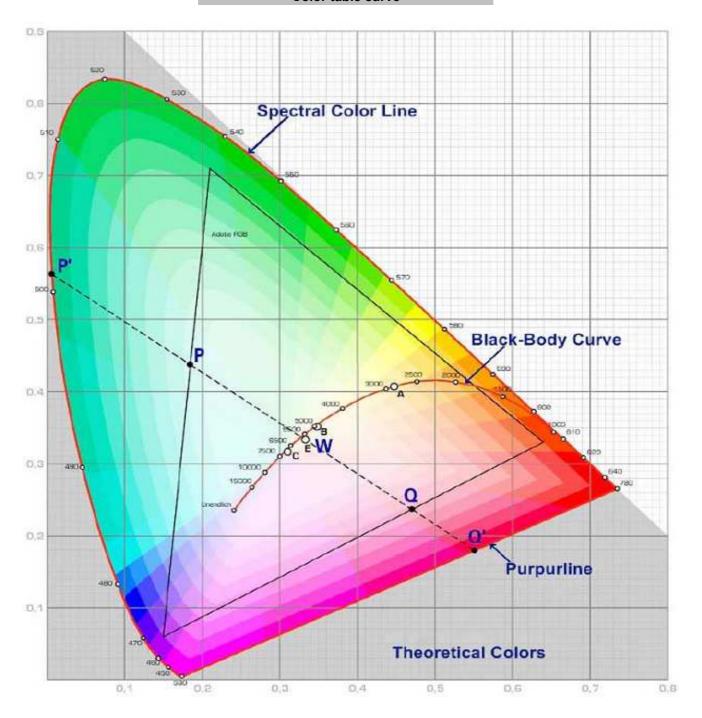








### Color table curve



5	SMT	Chip	LED
		Green	

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